



THE DATASHEET OF ZXTR2008K-13

Description

The ZXTR2008K monolithically integrates a transistor, Zener diode and resistor to function as a high voltage linear regulator. The device regulates with an 8.2V nominal output at 15mA. It is designed for use in high voltage applications where standard linear regulators cannot be used. This function is fully integrated into a TO252 package, minimizing PCB area and reducing number of components when compared with a multi-chip discrete solution.

Applications

Supply voltage regulation in:

- Startup switch in DC-DC converters
- Networking
- Telecommunications
- Power over Ethernet (PoE)

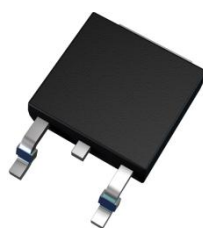
Features

- Series Linear Regulator Using Emitter-Follower Stage
- Input Voltage = 12V to 100V (For regulated output voltage)
- Output Voltage = 8.2V $\pm$ 10%
- 150k Ω resistor to limit quiescent current
- Fully integrated into a TO252 package
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 for High Reliability**

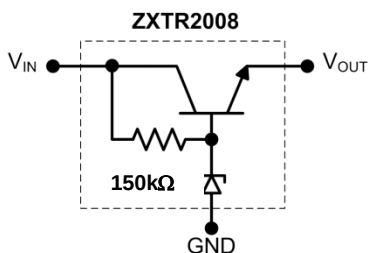
Mechanical Data

- Case: TO252 (DPAK)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Plated Leads. Solderable per MIL-STD-202, Method 208 
- Weight: 0.34 grams (Approximate)

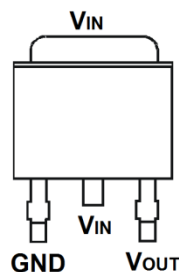
TO252 (DPAK)



Top View



Internal Device
Schematic



Top View
Pin-Out

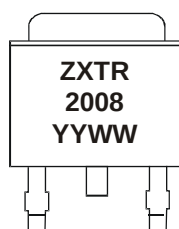
Pin Name	Pin Function
V _{IN}	Input Supply
GND	Power Ground
V _{OUT}	Voltage Output

Ordering Information (Note 4)

Product	Package	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTR2008K-13	TO252 (DPAK)	ZXTR 2008	13	16	2,500

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
 3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



ZXTR2008 = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Digit of Year, (ex: 17 = 2017)
WW = Week Code 01 - 52

Absolute Maximum Ratings (Voltage relative to GND, @T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Input Voltage	V _{IN}	-0.3 to 100	V
Continuous Input & Output Current	I _{IN} , I _{OUT}	550	mA
Peak Pulsed Input & Output Current	I _{IM} , I _{OM}	2	A
Maximum Voltage applied to V _{OUT}	V _{OUT(max)}	Smaller of V _{IN} +8.2V or 14.5V	V

Maximum Current at V_{IN} = 48V (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Continuous Output Current	I _{OUT}	55	mA
Pulsed Output Current	I _{OM}	900	mA
		190	mA

Thermal Characteristics

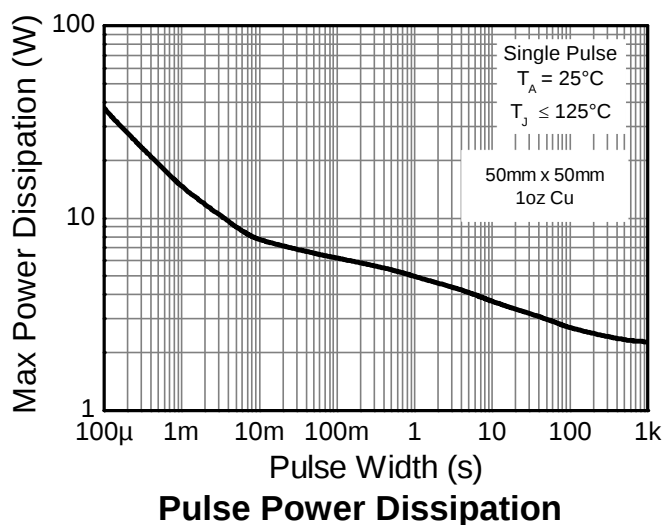
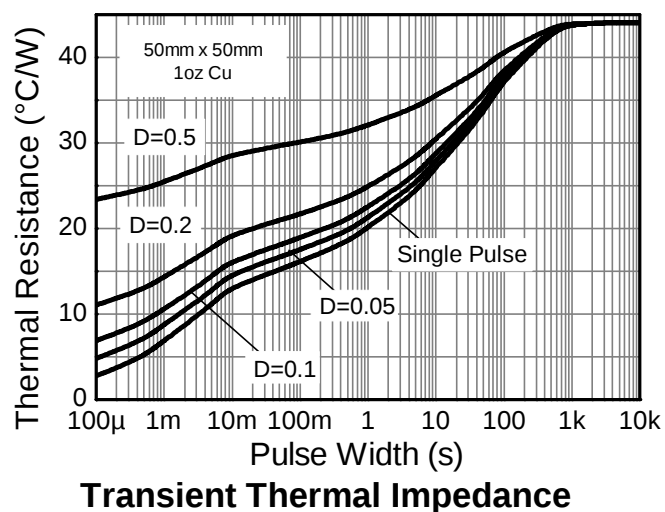
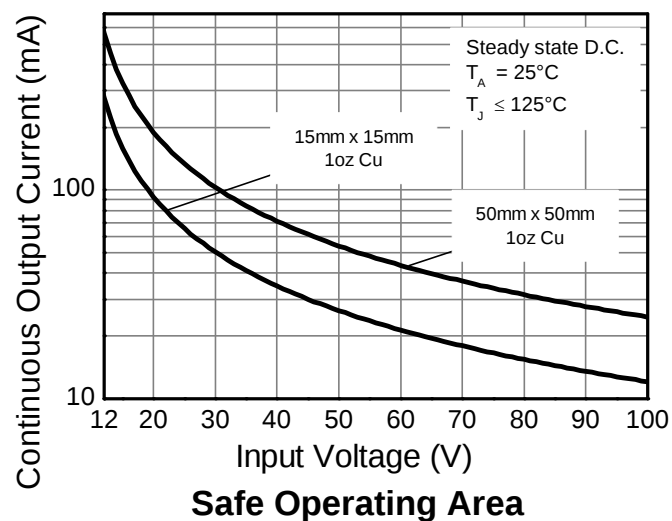
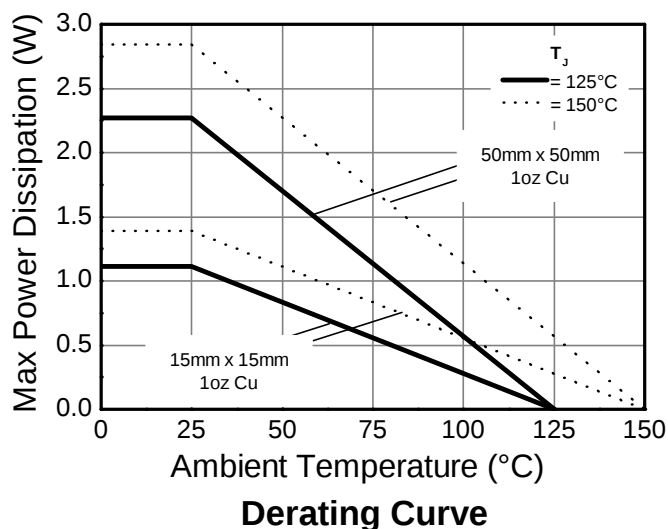
Characteristic	Symbol	Value	Unit
Power Dissipation	P _D	2.3	W
		1.1	W
Thermal Resistance, Junction to Ambient	R _{θJA}	44	°C/W
		90	°C/W
Thermal Resistance, Junction to Lead	R _{θJL}	8.4	°C/W
Thermal Resistance, Junction to Case	R _{θJC}	14.6	°C/W
Recommended Operating Junction Temperature Range	T _J	-40 to +125	°C
Maximum Operating Junction and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

ESD Ratings (Note 11)

Characteristics	Symbols	Value	Unit	JEDEC Class
Electrostatic Discharge – Human Body Model	ESD HBM	4000	V	3A
Electrostatic Discharge – Machine Model	ESD MM	400	V	C

- Notes:
- For a device mounted with the exposed V_{IN} pad on 50mm x 50mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in steady-state.
 - Same as note 5, except mounted on 15mm x 15mm 1oz copper.
 - Same as note 5, whilst operating at V_{IN} = 48V. Refer to Safe Operating Area for other Input Voltages.
 - Same as note 5, except measured with a single pulse width = 100μs and V_{IN} = 48V.
 - Same as note 5, except measured with a single pulse width = 10ms and V_{IN} = 48V.
 - R_{θJL} = Thermal resistance from junction to solder-point (on the exposed V_{IN} pad).
 - R_{θJC} = Thermal resistance from junction to the top of case.
 - Refer to JEDEC specification JESD22-A114 and JESD22-A115.

Thermal Characteristics and Derating Information



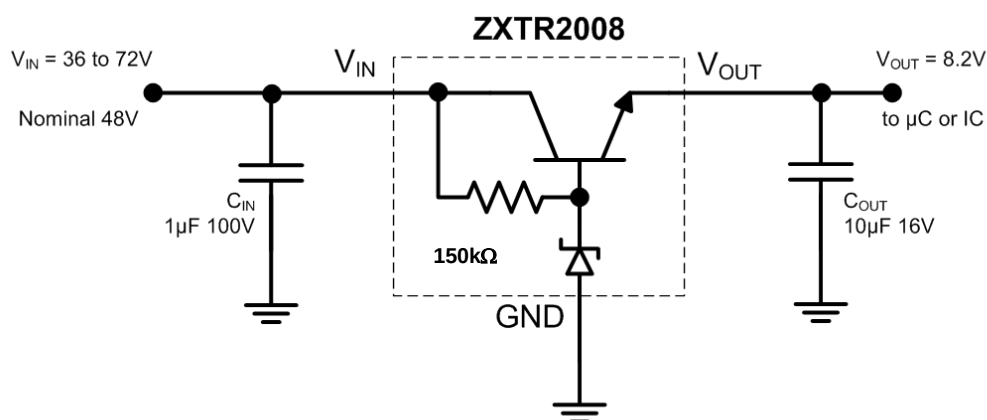
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Output Voltage (Note 12)	V _{OUT}	7.38	8.2	9.02	V	V _{IN} = 48V, I _{OUT} = 15mA
Line Regulation (Notes 12 & 13)	ΔV _{OUT}	—	10	300	mV	V _{IN} = 12 to 100V, I _{OUT} = 15mA
Temperature Coefficient	ΔV _{OUT} /ΔT	—	10	—	mV/°C	T _J = -40°C to +125°C V _{IN} = 48V, I _{OUT} = 15mA
Load Regulation (Notes 12 & 14)	ΔV _{OUT}	—	-180 -250	-400 -500	mV	I _{OUT} = 0.1 to 30mA, V _{IN} = 48V I _{OUT} = 0.1 to 100mA, V _{IN} = 48V
Minimum Value of Input Voltage Required to Maintain Line Regulation	V _{IN(MIN)}	12	—	—	V	—
Quiescent Current	I _Q	—	275 650	500 900	μA	V _{IN} = 48V, I _{OUT} = 10μA V _{IN} = 100V, I _{OUT} = 10μA
Power Supply Rejection Ratio	ΔV _{IN} /ΔV _{OUT}	—	38	—	dB	C _{OUT} = 100nF, I _{OUT} = 15mA, V _{OUT} = 8.2V, V _{IN} =12 to 100V, f=100Hz

Notes:

- 12. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%
- 13. Line regulation ΔV_{OUT} = V_{OUT}(@ V_{IN} = 100V) – V_{OUT}(@ V_{IN} = 12V)
- 14. Load regulation ΔV_{OUT} = V_{OUT}(@ I_{OUT} = 30mA) – V_{OUT}(@ I_{OUT} = 0.1mA)
ΔV_{OUT} = V_{OUT}(@ I_{OUT} = 100mA) – V_{OUT}(@ I_{OUT} = 0.1mA)

Typical Application Circuit

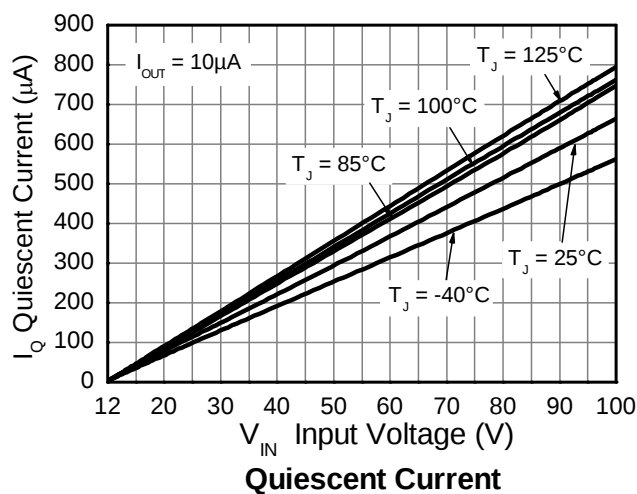
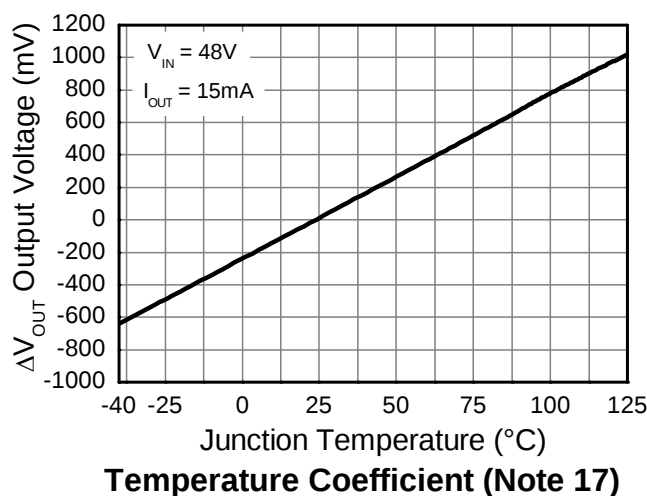
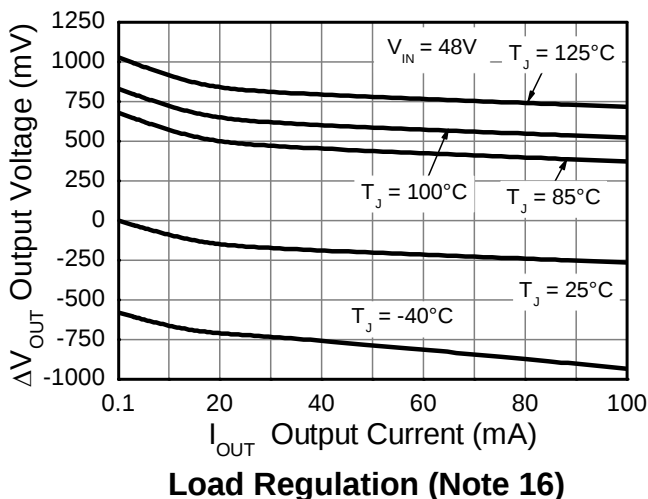
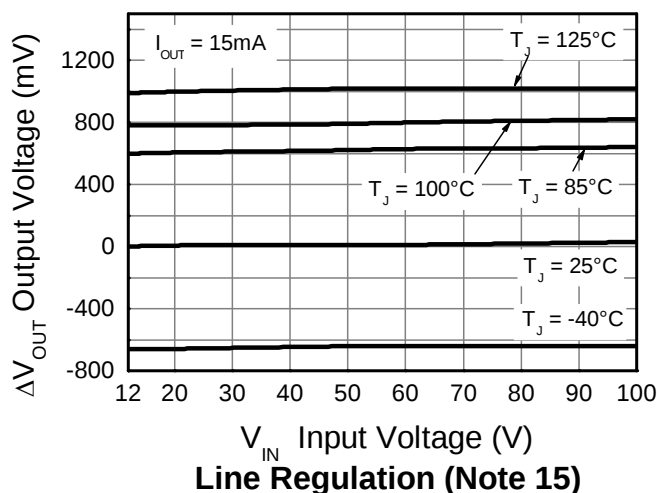
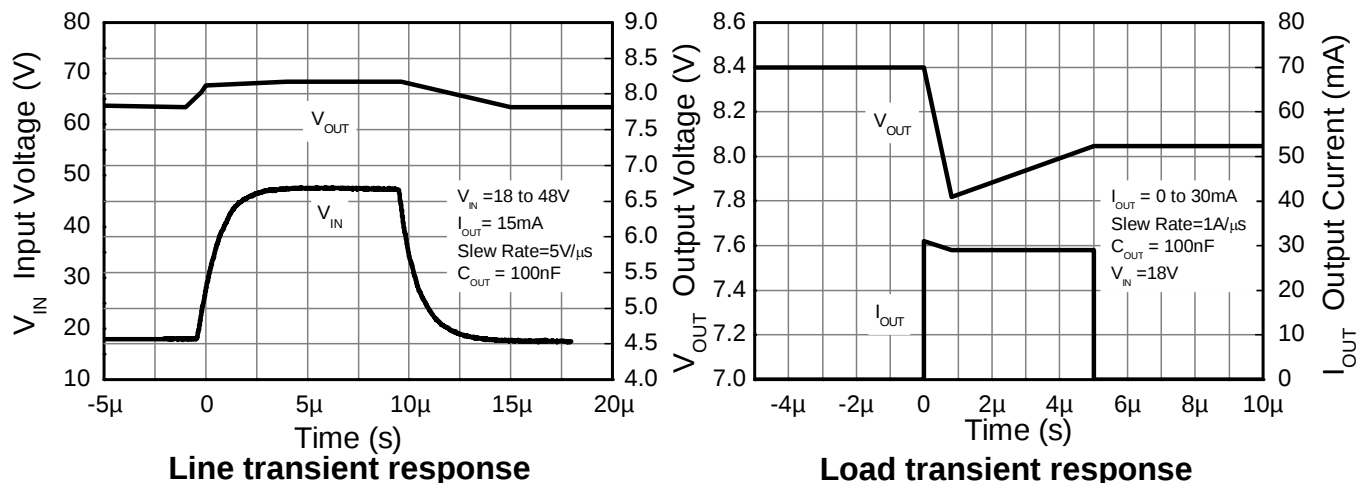


Example of an 8.2V regulated supply from a nominal 48V for powering a Controller IC.

Pin Functions

Pin Name	Pin Function	Notes
V _{IN}	Input Supply	Input voltage can vary from -0.3V to 100V with respect to GND; for V _{OUT} regulated then 12V ≤ V _{IN} ≤ 100V. It is recommended to connect a 1μF capacitor to GND.
GND	Power Ground	This pin should be tied to the system ground.
V _{OUT}	Voltage Output	Outputs a regulated 8V when 12V ≤ V _{IN} ≤ 100V. When V _{IN} < 12V, then V _{OUT} maximum = V _{IN} – 1.5V. The pin can be pulled high to a maximum of +14V with respect to GND, or +8V with respect to V _{IN} , whichever is lower. It is recommended to connect a 10μF capacitor to GND and a minimum of 10μA to be drawn from V _{OUT} to maintain regulation.

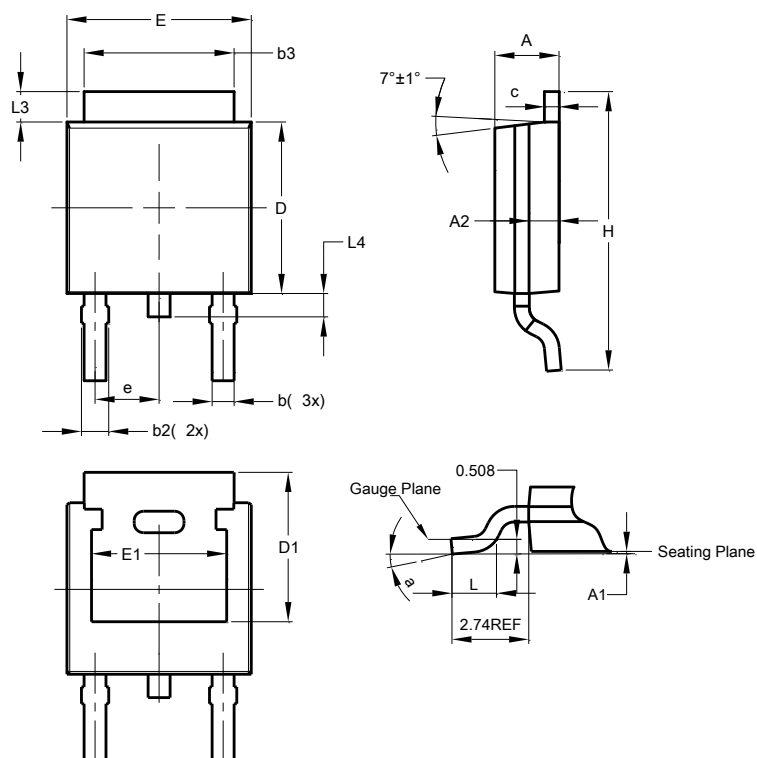
Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)



- Notes:
- 15. Line regulation $\Delta V_{OUT} = V_{OUT} - V_{OUT}(@ V_{IN} = 12\text{V}, I_{OUT} = 15\text{mA}, T_J = +25^\circ\text{C})$
 - 16. Load regulation $\Delta V_{OUT} = V_{OUT} - V_{OUT}(@ V_{IN} = 48\text{V}, I_{OUT} = 0.1\text{mA}, T_J = +25^\circ\text{C})$
 - 17. Temperature Coefficient $\Delta V_{OUT} = V_{OUT} - V_{OUT}(@ V_{IN} = 48\text{V}, I_{OUT} = 15\text{mA}, T_J = +25^\circ\text{C})$

Package Outline Dimensions

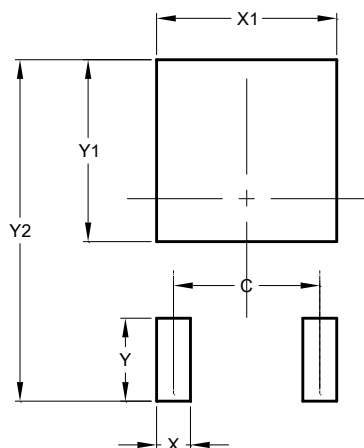
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



TO252 (DPAK)			
Dim	Min	Max	Typ
A	2.19	2.39	2.29
A1	0.00	0.13	0.08
A2	0.97	1.17	1.07
b	0.64	0.88	0.783
b2	0.76	1.14	0.95
b3	5.21	5.46	5.33
c	0.45	0.58	0.531
D	6.00	6.20	6.10
D1	5.21	-	-
e	-	-	2.286
E	6.45	6.70	6.58
E1	4.32	-	-
H	9.40	10.41	9.91
L	1.40	1.78	1.59
L3	0.88	1.27	1.08
L4	0.64	1.02	0.83
a	0°	10°	-
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	4.572
X	1.060
X1	5.632
Y	2.600
Y1	5.700
Y2	10.700

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